

## General Description

The AGM405Q combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ .

This device is ideal for load switch and battery protection applications.

## Features

- Advance high cell density Trench technology
- Low  $R_{DS(ON)}$  to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

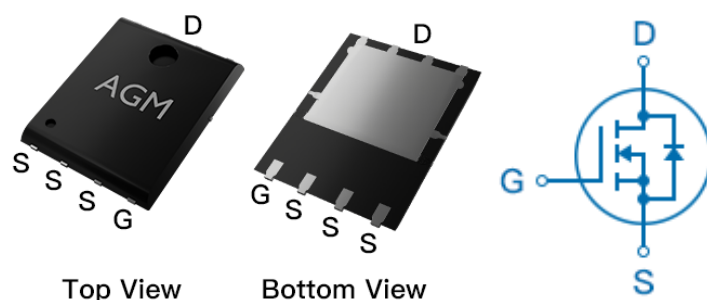
## Application

- MB/VGA Vcore
- SMPS 2<sup>nd</sup> Synchronous Rectifier
- POL application
- BLDC Motor driver

## Product Summary

| BVDSS | RDSON | ID  |
|-------|-------|-----|
| 40V   | 5.7mΩ | 55A |

## PDFN5\*6 Pin Configuration



## Package Marking and Ordering Information

| Device Marking | Device  | Device Package | Reel Size | Tape width | Quantity |
|----------------|---------|----------------|-----------|------------|----------|
| AGM405Q        | AGM405Q | PDFN5*6        | 330mm     | 12mm       | 3000     |

**Table 1. Absolute Maximum Ratings (TA=25°C)**

| Symbol      | Parameter                                         | Value      | Unit |
|-------------|---------------------------------------------------|------------|------|
| VDS         | Drain-Source Voltage (VGS=0V)                     | 40         | V    |
| VGS         | Gate-Source Voltage (VDS=0V)                      | ±20        | V    |
| ID          | Drain Current-Continuous(Tc=25°C) <b>(Note 1)</b> | 55         | A    |
|             | Drain Current-Continuous(Tc=100°C)                | 33         | A    |
| IDM (pluse) | Drain Current-Pulsed <b>(Note 2)</b>              | 220        | A    |
| PD          | Maximum Power Dissipation(Tc=25°C)                | 28         | w    |
|             | Maximum Power Dissipation(Tc=100°C)               | 11         | w    |
| EAS         | Avalanche energy <b>(Note 3)</b>                  | 72         | mJ   |
| TJ,TSTG     | Operating Junction and Storage Temperature Range  | -55 To 150 | °C   |

**Table 2. Thermal Characteristic**

| Symbol | Parameter                                                       | Typ | Max | Unit |
|--------|-----------------------------------------------------------------|-----|-----|------|
| RθJA   | Thermal Resistance Junction-ambient (Steady State) <sup>1</sup> | --- | 60  | °C/W |
| RθJC   | Thermal Resistance Junction-Case <sup>1</sup>                   | --- | 4.5 | °C/W |

**Table 3. Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)**

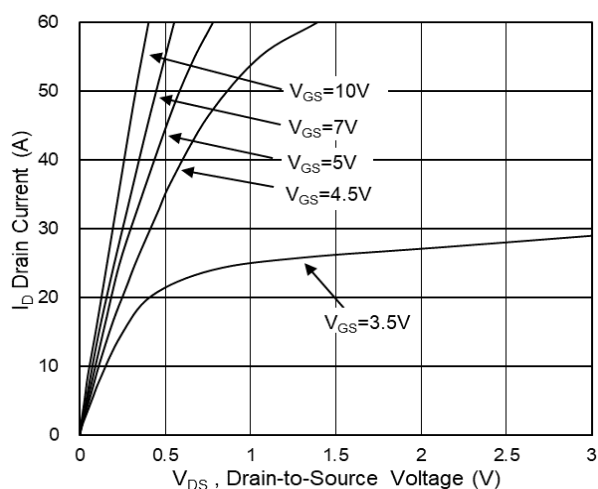
| Symbol                             | Parameter                        | Conditions                             | Min | Typ  | Max  | Unit |
|------------------------------------|----------------------------------|----------------------------------------|-----|------|------|------|
| On/Off States                      |                                  |                                        |     |      |      |      |
| BVDSS                              | Drain-Source Breakdown Voltage   | VGS=0V ID=250μA                        | 40  | --   | --   | V    |
| IDSS                               | Zero Gate Voltage Drain Current  | VDS=40V,VGS=0V                         | --  | --   | 1    | μA   |
| IGSS                               | Gate-Body Leakage Current        | VGS=±20V,VDS=0V                        | --  | --   | ±100 | nA   |
| VGS(th)                            | Gate Threshold Voltage           | VDS=VGS,ID=250μA                       | 1.2 | 1.6  | 2.2  | V    |
| gFS                                | Forward Transconductance         | VDS=5V,ID=15A                          | --  | 17   | --   | S    |
| RDS(on)                            | Drain-Source On-State Resistance | VGS=10V, ID=20A                        | --  | 5.7  | 8.0  | mΩ   |
|                                    |                                  | VGS=4.5V, ID=15A                       | --  | 9.5  | 14   | mΩ   |
| Dynamic Characteristics            |                                  |                                        |     |      |      |      |
| Ciss                               | Input Capacitance                | VDS=20V,VGS=0V<br>,F=1MHZ              | --  | 775  | --   | pF   |
| Coss                               | Output Capacitance               |                                        | --  | 225  | --   | pF   |
| Crss                               | Reverse Transfer Capacitance     |                                        | --  | 37   | --   | pF   |
| Rg                                 | Gate resistance                  | VGS=0V,<br>VDS=0V,f=1.0MHz             | --  | 1.35 | --   | Ω    |
| Switching Times                    |                                  |                                        |     |      |      |      |
| td(on)                             | Turn-on Delay Time               | VGS=10V,VDS=15V,<br>RL=0.75Ω,RGEN=3.3Ω | --  | 13.9 | --   | nS   |
| tr                                 | Turn-on Rise Time                |                                        | --  | 5.7  | --   | nS   |
| td(off)                            | Turn-Off Delay Time              |                                        | --  | 20   | --   | nS   |
| tf                                 | Turn-Off Fall Time               |                                        | --  | 11   | --   | nS   |
| Qg                                 | Total Gate Charge                | VGS=10V, VDS=25V,<br>ID=12A            | --  | 5.7  | --   | nC   |
| Qgs                                | Gate-Source Charge               |                                        | --  | 3.0  | --   | nC   |
| Qgd                                | Gate-Drain Charge                |                                        | --  | 1.2  | --   | nC   |
| Source-Drain Diode Characteristics |                                  |                                        |     |      |      |      |
| ISD                                | Source-Drain Current(Body Diode) |                                        | --  | --   | 55   | A    |
| VSD                                | Forward on Voltage               | VGS=0V,IS=20A                          | --  | --   | 1.2  | V    |

Notes 1.The maximum current rating is package limited.

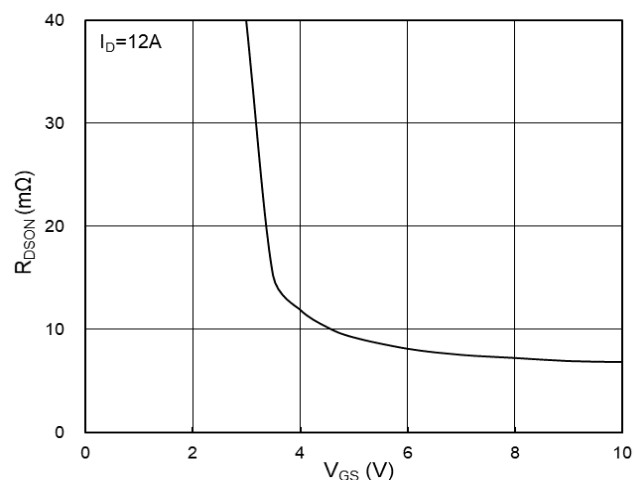
Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: T<sub>J</sub>=25°C, V<sub>DD</sub>=25V, V<sub>gs</sub>=10V, I<sub>D</sub>=17A, L=0.5mH, R<sub>G</sub>=25ohm

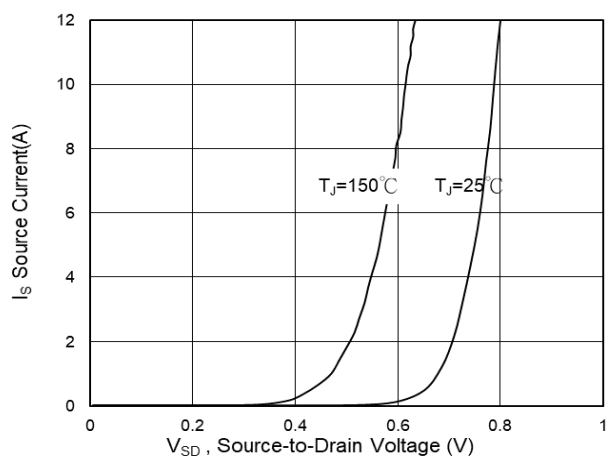
## Typical Characteristics



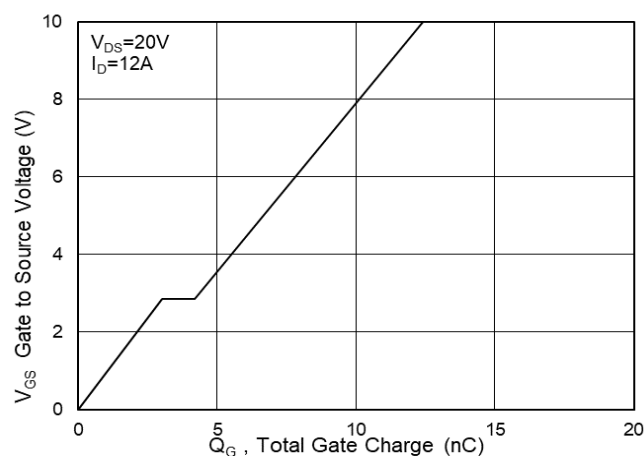
**Fig.1 Typical Output Characteristics**



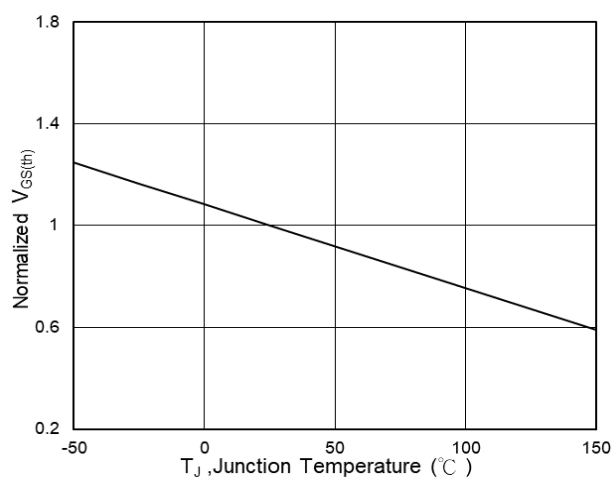
**Fig.2 On-Resistance vs. G-S Voltage**



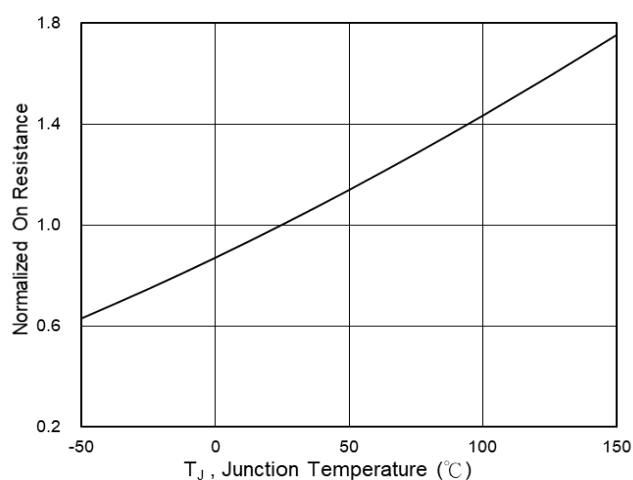
**Fig.3 Source Drain Forward Characteristics**



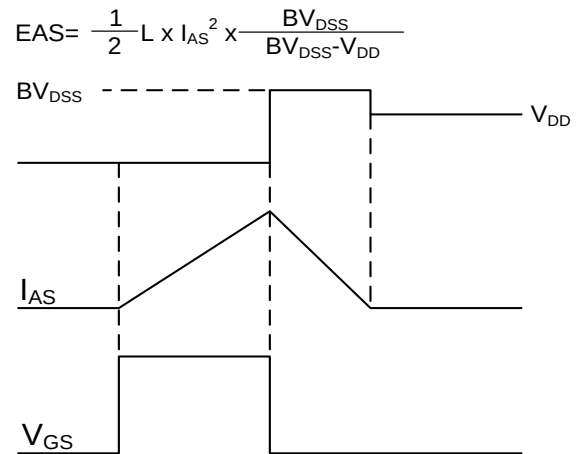
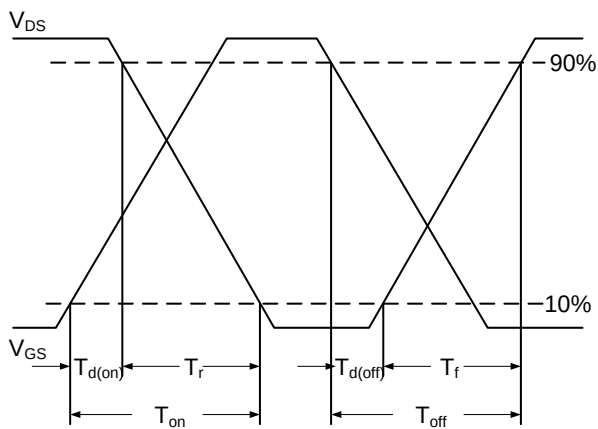
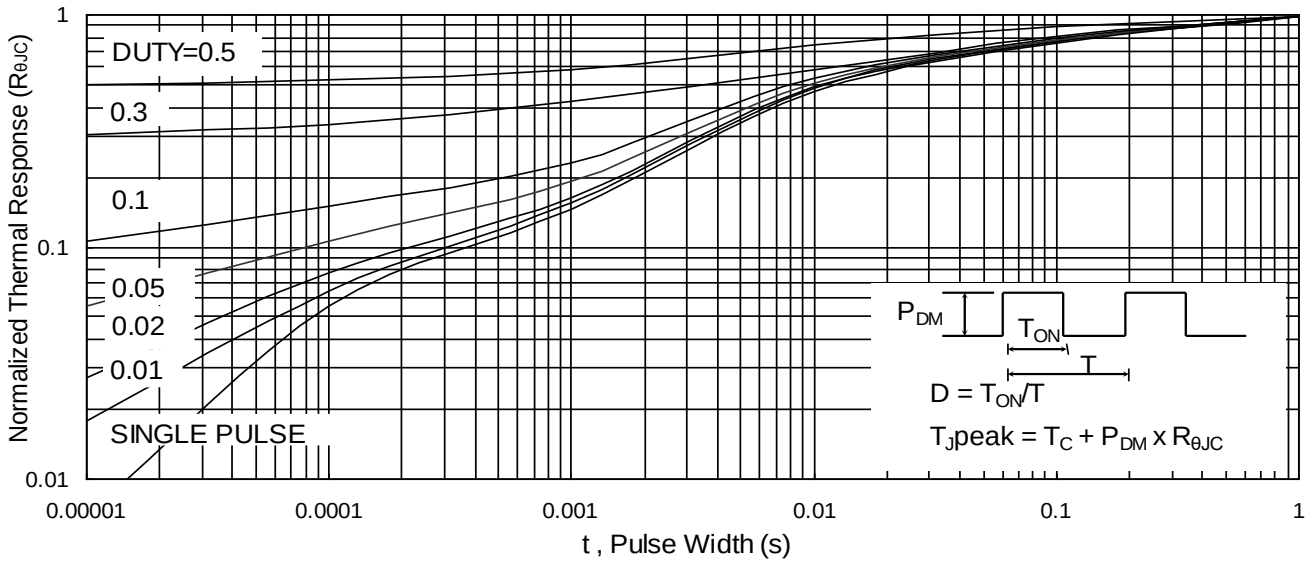
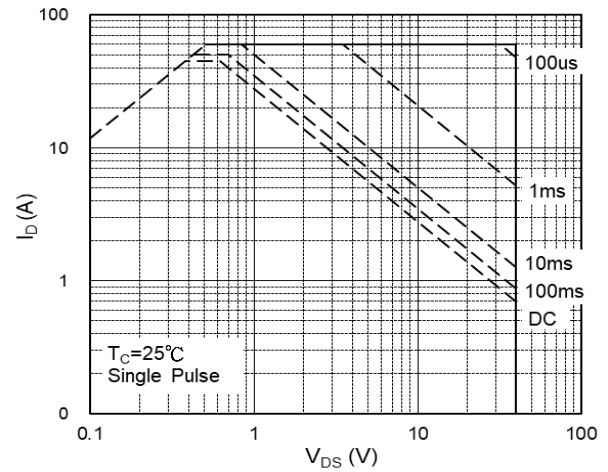
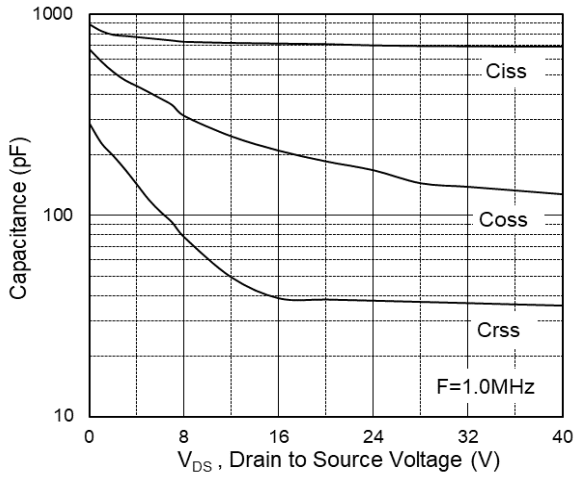
**Fig.4 Gate-Charge Characteristics**



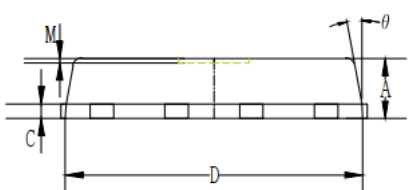
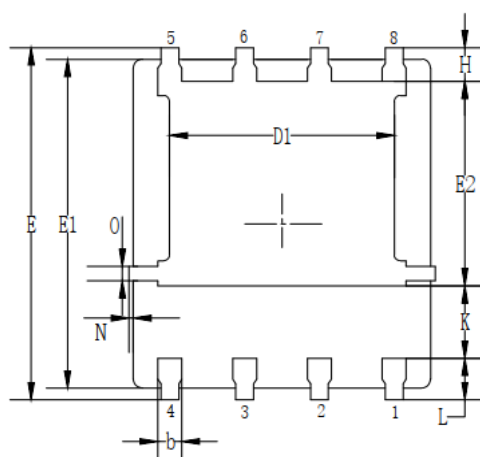
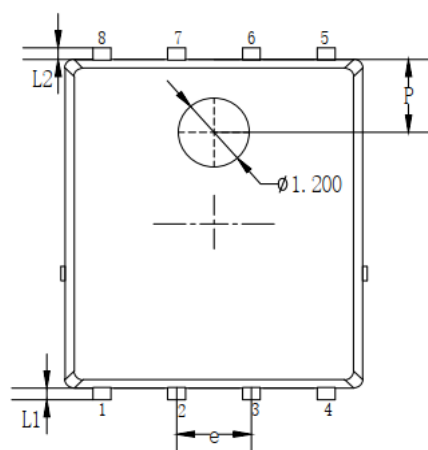
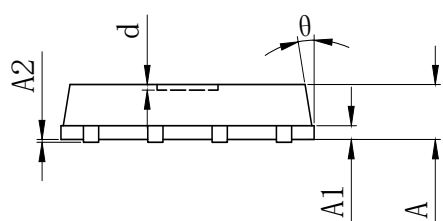
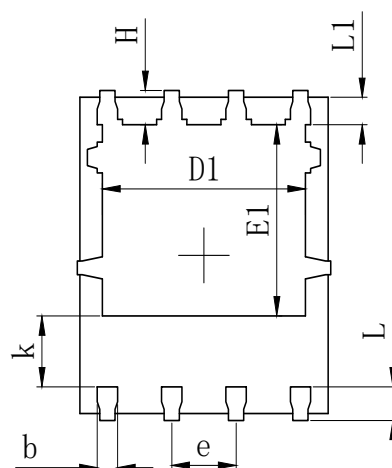
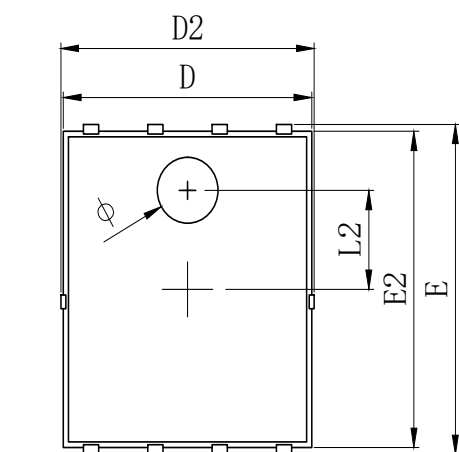
**Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$**



**Fig.6 Normalized  $R_{DS(on)}$  vs.  $T_J$**



# Dimensions (PDFN5\*6)



| SYMBOL | MILLIMETER |       |       |
|--------|------------|-------|-------|
|        | MIN        | Typ.  | MAX   |
| A      | 0.900      | 1.000 | 1.100 |
| A1     | 0.254 REF. |       |       |
| A2     | 0°~0.05    |       |       |
| D      | 4.824      | 4.900 | 4.976 |
| D1     | 3.910      | 4.010 | 4.110 |
| D2     | 4.924      | 5.000 | 5.076 |
| E      | 5.924      | 6.000 | 6.076 |
| E1     | 3.375      | 3.475 | 3.575 |
| E2     | 5.674      | 5.750 | 5.826 |
| b      | 0.350      | 0.400 | 0.450 |
| e      | 1.270 TYP. |       |       |
| L      | 0.534      | 0.610 | 0.686 |
| L1     | 0.424      | 0.500 | 0.576 |
| L2     | 1.800 REF. |       |       |
| k      | 1.190      | 1.290 | 1.390 |
| H      | 0.549      | 0.625 | 0.701 |
| θ      | 8°         | 10°   | 12°   |
| φ      | 1.100      | 1.200 | 1.300 |
| d      |            |       | 0.100 |

| Symbols | Millimeters |      |      |
|---------|-------------|------|------|
|         | MIN.        | NOM. | MAX. |
| A       | 0.90        | 1.05 | 1.20 |
| b       | 0.35        | 0.40 | 0.50 |
| C       | 0.20        | 0.25 | 0.35 |
| D       | 4.90        | 5.05 | 5.20 |
| D1      | 3.72        | 3.82 | 3.92 |
| E       | 6.00        | 6.15 | 6.30 |
| E1      | 5.60        | 5.75 | 5.90 |
| E2      | 3.47        | 3.57 | 3.67 |
| e       | 1.27 BSC.   |      |      |
| H       | 0.48        | 0.58 | 0.68 |
| K       | 1.17        | 1.27 | 1.37 |
| L       | 0.64        | 0.74 | 0.84 |
| L1/L2   | 0.20 REF.   |      |      |
| θ       | 8°          | 10°  | 12°  |
| M       | 0.08 REF.   |      |      |
| N       | 0           | -    | 0.15 |
| O       | 0.25 REF.   |      |      |
| P       | 1.28 REF.   |      |      |

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